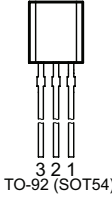



|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; T2- G+;<br>$T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 7</a>  |  | -   | -   | 7   | mA               |
|--------------------------------|---------------------------------------|--|--|-----|-----|-----|------------------|
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 9</a>  |  | -   | 1.3 | 10  | mA               |
| $V_T$                          | on-state voltage                      | $I_T = 1.4\text{ A}$ ; $T_j = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 10</a>  |  | -   | 1.2 | 1.5 | V                |
| Symbol                         | Parameter                             | Conditions   |  | Min | Typ | Max | Unit             |
| <b>Dynamic characteristics</b> |                                       |  |  |     |     |     |                  |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 402\text{ V}$ ; $T_j = 125\text{ }^\circ\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform;<br>$R_{GT1(ext)} = 1\text{ k}\Omega$ |  | 20  | -   | -   | V/ $\mu\text{s}$ |
| $dV_{com}/dt$                  | rate of change of commutating voltage | $V_D = 400\text{ V}$ ; $T_j = 125\text{ }^\circ\text{C}$ ; $dI_{com}/dt = 0.5\text{ A/ms}$ ;<br>$I_T = 1\text{ A}$ ; gate open circuit                     |  | 3   | -   | -   | V/ $\mu\text{s}$ |

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description     | Simplified outline  | Graphic symbol   |
|-----|--------|-----------------|---|--|
| 1   | T2     | main terminal 2 | <br>TO-92 (SOT54) | <br>sym051 |
| 2   | G      | gate            |   |  |
| 3   | T1     | main terminal 1 |   |  |

## 6. Ordering information

Table 3. Ordering information

| Type number    | Package Name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date |
|----------------|--------------|-----------------------|----------------|------------------------|-----------------|--------------------|
| BT131-600D     | TO92         | BT131-600D,412        | Bulk           | 1000                   | SOT54           | 14-Nov-2013        |
| BT131-600D     | TO92         | BT131-600DQP          | Reel           | 2000                   | SOT54           | 14-Nov-2013        |
| BT131-600D/L01 | TO92         | BT131-600D/L01EP      | Bulk           | 500                    | SOT54/L01       | 14-Nov-2013        |

## 7. Marking

Table 4. Marking codes

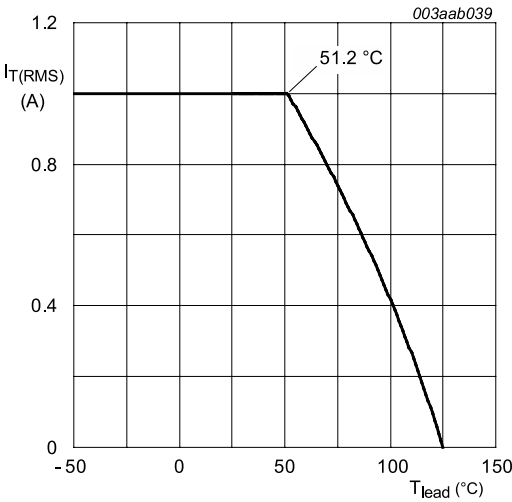
| Type number | Marking codes |
|-------------|---------------|
| BT131-600D  | 131-6D        |

# 8. Limiting values

**Table 5. Limiting values**

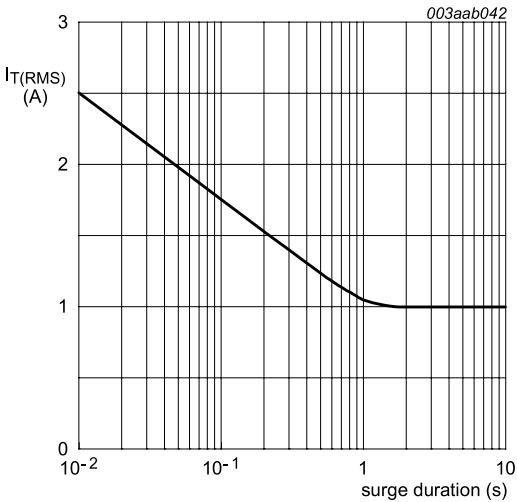
*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol       | Parameter                            | Conditions   | Min | Max  | Unit                   |
|--------------|--------------------------------------|--|-----|------|------------------------|
| $V_{DRM}$    | repetitive peak off-state voltage    |  | -   | 600  | V                      |
| $I_{T(RMS)}$ | RMS on-state current                 | full sine wave; $T_{lead} \leq 51\text{ }^{\circ}\text{C}$ ; <a href="#">Fig 1</a> ; <a href="#">Fig 2</a> ; <a href="#">Fig 3</a> | -   | 1    | A                      |
| $I_{TSM}$    | non-repetitive peak on-state current | full sine wave; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$ ; $t_p = 20\text{ ms}$ ; <a href="#">Fig 4</a> ; <a href="#">Fig 5</a>  | -   | 12.5 | A                      |
|              |                                      | full sine wave; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$ ; $t_p = 16.7\text{ ms}$  | -   | 13.7 | A                      |
| $I^2t$       | $I^2t$ for fusing                    | $t_p = 10\text{ ms}$ ; SIN   | -   | 0.78 | $\text{A}^2\text{s}$   |
| $di_T/dt$    | rate of rise of on-state current     | $I_G = 10\text{ mA}$   | -   | 50   | $\text{A}/\mu\text{s}$ |
|              |                                      | $I_G = 10\text{ mA}$   | -   | 50   | $\text{A}/\mu\text{s}$ |
|              |                                      | $I_G = 14\text{ mA}$   | -   | 10   | $\text{A}/\mu\text{s}$ |
|              |                                      | $I_G = 10\text{ mA}$   | -   | 50   | $\text{A}/\mu\text{s}$ |
| $I_{GM}$     | peak gate current                    |  | -   | 2    | A                      |
| $P_{GM}$     | peak gate power                      |  | -   | 5    | W                      |
| $P_{G(AV)}$  | average gate power                   | over any 20 ms period  | -   | 0.1  | W                      |
| $T_{stg}$    | storage temperature                  |  | -40 | 150  | $^{\circ}\text{C}$     |
| $T_j$        | junction temperature                 |  | -   | 125  | $^{\circ}\text{C}$     |



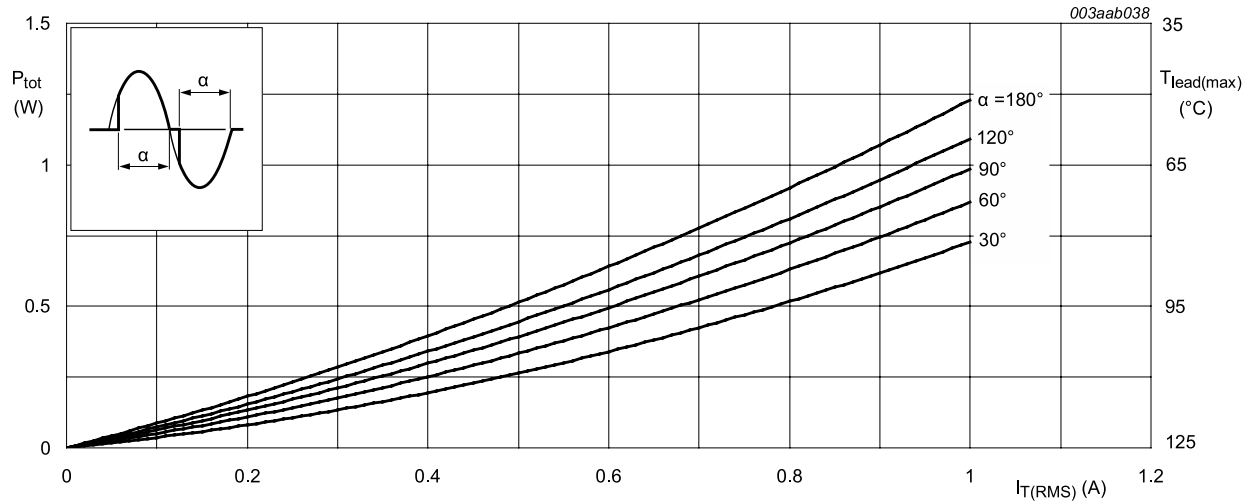
$T_{lead} = 51.2\text{ }^{\circ}\text{C}$

**Fig. 1. RMS on-state current as a function of lead temperature; maximum values**



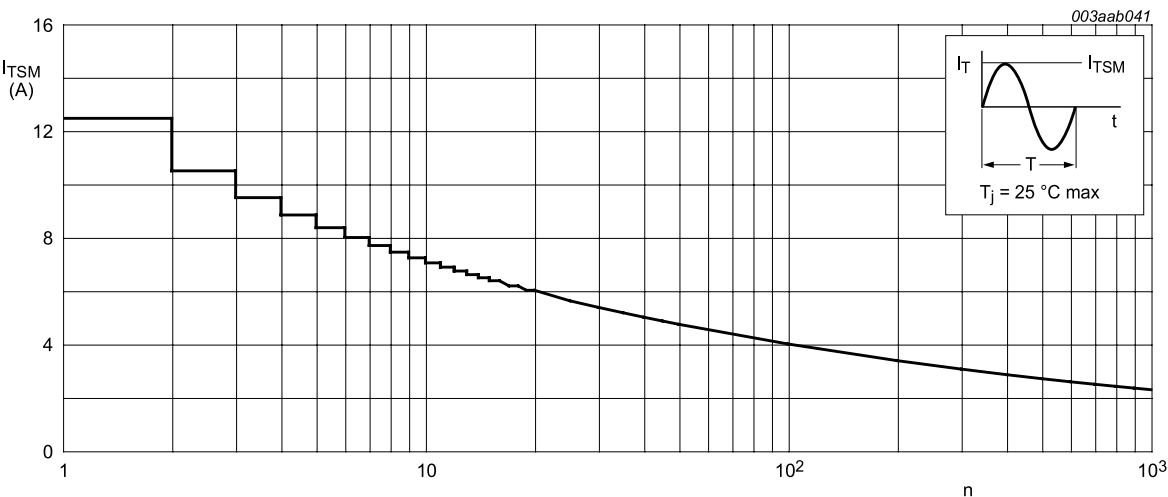
$f = 50\text{ Hz}$ ;  $T_{lead} = 51.2\text{ }^{\circ}\text{C}$

**Fig. 2. RMS on-state current as a function of surge duration; maximum values**



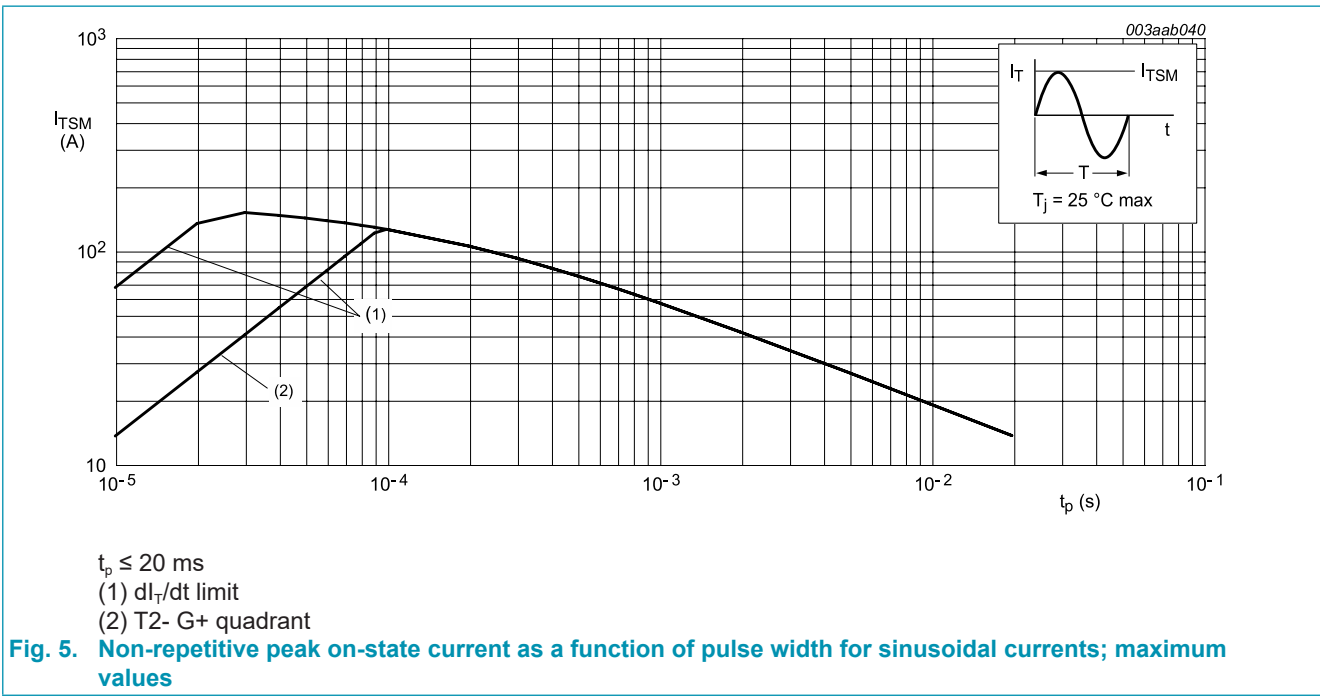
$\alpha$  = conduction angle

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values



$f = 50\text{ Hz}$

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



9. Thermal characteristics

Table 6. Thermal characteristics

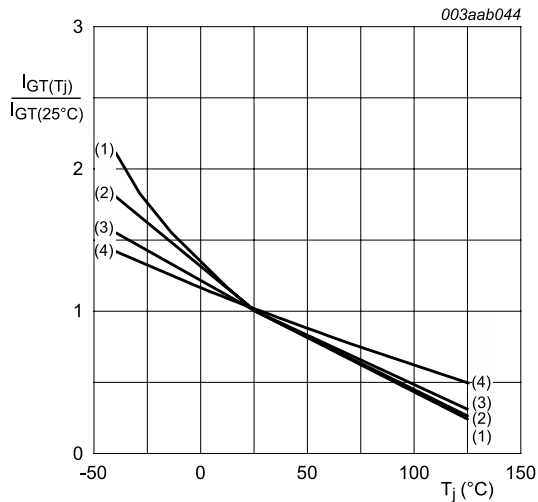
| Symbol           | Parameter  | Conditions  | Min | Typ | Max | Unit |
|------------------|--|---|-----|-----|-----|------|
| $R_{th(j-lead)}$ | thermal resistance from junction to lead             | full cycle; Fig 6                                 | -   | -   | 60  | K/W  |
|                  |  | half cycle; Fig 6                                 | -   | -   | 80  | K/W  |
| $R_{th(j-a)}$    | thermal resistance from junction to ambient free air | printed circuit board mounted: lead length = 4 mm | -   | 150 | -   | K/W  |



## 10. Characteristics

Table 7. Characteristics

| Symbol                         | Parameter                             | Conditions   |  | Min | Typ | Max | Unit             |
|--------------------------------|---------------------------------------|--|--|-----|-----|-----|------------------|
| <b>Static characteristics</b>  |                                       |  |  |     |     |     |                  |
| $I_{GT}$                       | gate trigger current                  | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; T2+ G+;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 7</a>  |  | -   | -   | 5   | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; T2+ G-;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 7</a>  |  | -   | -   | 5   | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; T2- G-;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 7</a>  |  | -   | -   | 5   | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; T2- G+;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 7</a>  |  | -   | -   | 7   | mA               |
| $I_L$                          | latching current                      | $V_D = 12\text{ V}$ ; $I_G = 0.1\text{ A}$ ; T2+ G+;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>  |  | -   | -   | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 0.1\text{ A}$ ; T2+ G-;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>  |  | -   | -   | 20  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 0.1\text{ A}$ ; T2- G-;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>  |  | -   | -   | 10  | mA               |
|                                |                                       | $V_D = 12\text{ V}$ ; $I_G = 0.1\text{ A}$ ; T2- G+;<br>$T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 8</a>  |  | -   | -   | 10  | mA               |
| $I_H$                          | holding current                       | $V_D = 12\text{ V}$ ; $T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 9</a>  |  | -   | 1.3 | 10  | mA               |
| $V_T$                          | on-state voltage                      | $I_T = 1.4\text{ A}$ ; $T_J = 25\text{ }^\circ\text{C}$ ; <a href="#">Fig. 10</a>  |  | -   | 1.2 | 1.5 | V                |
| $V_{GT}$                       | gate trigger voltage                  | $V_D = 12\text{ V}$ ; $I_T = 0.1\text{ A}$ ; $T_J = 25\text{ }^\circ\text{C}$ ;<br><a href="#">Fig. 11</a>   |  | -   | 0.7 | 1   | V                |
|                                |                                       | $V_D = 400\text{ V}$ ; $I_T = 0.1\text{ A}$ ; $T_J = 125\text{ }^\circ\text{C}$  |  | 0.2 | 0.3 | -   | V                |
| $I_D$                          | off-state current                     | $V_D = 600\text{ V}$ ; $T_J = 125\text{ }^\circ\text{C}$   |  | -   | 0.1 | 0.5 | mA               |
| <b>Dynamic characteristics</b> |                                       |  |  |     |     |     |                  |
| $dV_D/dt$                      | rate of rise of off-state voltage     | $V_{DM} = 402\text{ V}$ ; $T_J = 125\text{ }^\circ\text{C}$ ; ( $V_{DM} = 67\%$ of $V_{DRM}$ ); exponential waveform;<br>$R_{GT1(ext)} = 1\text{ k}\Omega$ |  | 20  | -   | -   | V/ $\mu\text{s}$ |
| $dV_{com}/dt$                  | rate of change of commutating voltage | $V_D = 400\text{ V}$ ; $T_J = 125\text{ }^\circ\text{C}$ ; $dI_{com}/dt = 0.5\text{ A/ms}$ ; $I_T = 1\text{ A}$ ; gate open circuit                        |  | 3   | -   | -   | V/ $\mu\text{s}$ |
| $t_{gt}$                       | gate-controlled turn-on time          | $I_{TM} = 1.5\text{ A}$ ; $V_D = 600\text{ V}$ ; $I_G = 0.1\text{ A}$ ; $dI_G/dt = 5\text{ A}/\mu\text{s}$   |  | -   | 2   | -   | $\mu\text{s}$    |



- (1) T2- G+
- (2) T2- G-
- (3) T2+ G-
- (4) T2+ G+

Fig. 7. Normalized gate trigger current as a function of junction temperature

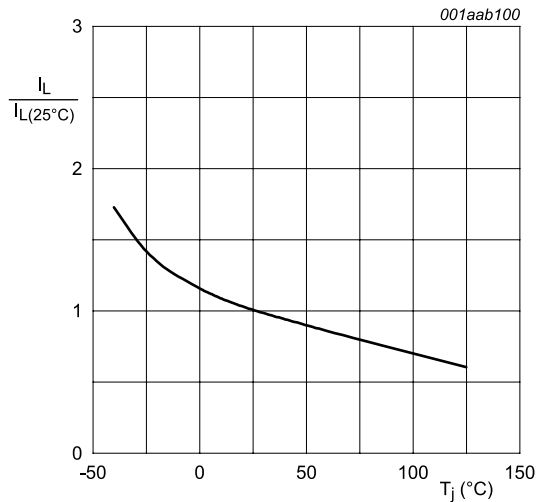


Fig. 8. Normalized latching current as a function of junction temperature

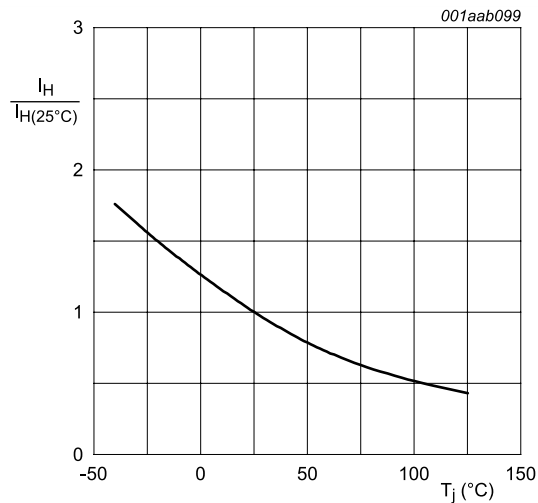
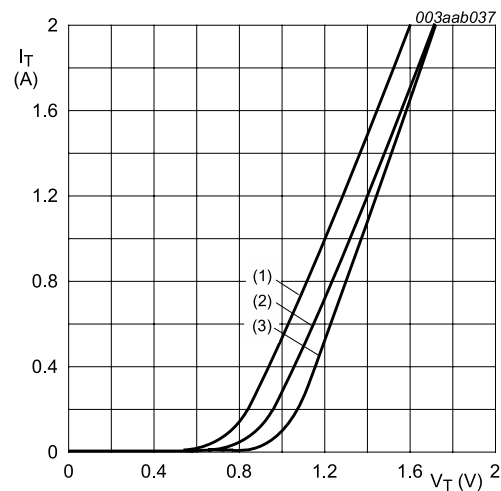


Fig. 9. Normalized holding current as a function of junction temperature



- $V_o = 0.92\text{ V}; R_s = 0.4\ \Omega$
- (1)  $T_j = 125^\circ\text{C}$ ; typical values
  - (2)  $T_j = 125^\circ\text{C}$ ; maximum values
  - (3)  $T_j = 25^\circ\text{C}$ ; maximum values

Fig. 10. On-state current as a function of on-state voltage

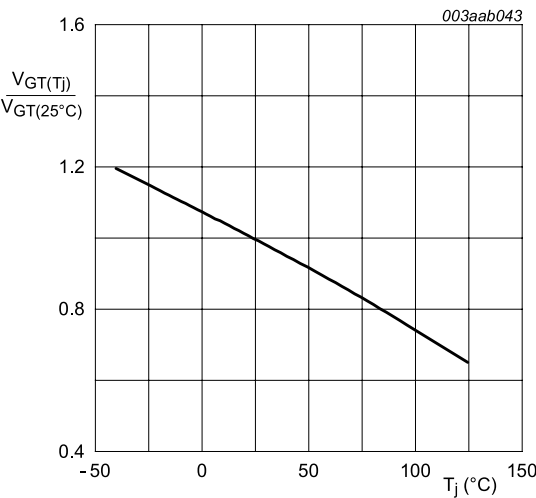
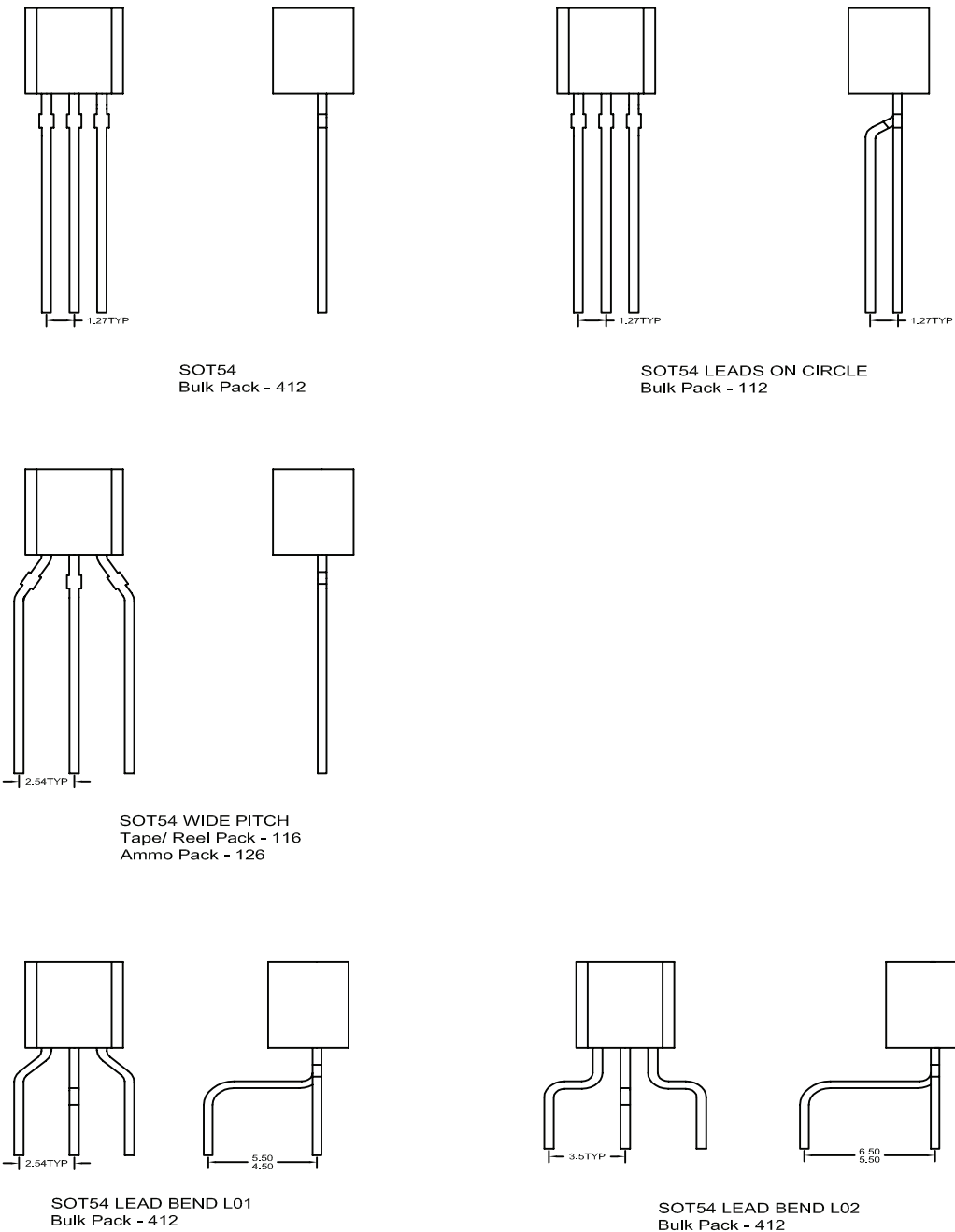


Fig. 11. Normalized gate trigger voltage as a function of junction temperature



11. Package outline

SOT54 PACKAGE OUTLINE



Remark: Detailed dimensions refer to POD drawing.

## 12. Legal information

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| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 23 December 2019